

# Gate Controlled 2-DEG Varactor for VCO Applications in Microwave Circuits

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**Abstract** — A novel gate-controlled Schottky diode varactor is introduced. The three-terminal varactor is a modulation-doped heterostructure of AlGaAs/GaAs with two Schottky contacts, similar to a metal-semiconductor-metal (MSM) diode. Schottky metal contacts are made to a two dimensional electron gas (2-DEG). The third gate contact is formed from highly doped n<sup>+</sup> GaAs material to allow an open optical window that can be used for optical gating and mixing. Structure capacitance is less than 1 PF and a change of more than 30 percent from the zero bias capacitance is observed with the applied gate voltage. On the basis of our quasi two-dimensional C-V model, the layer structure and device dimensions can be optimized and scaled to cover a wide range of operation in the microwave and millimeter wave regimes

**Key words** — Varactor, voltage controlled oscillator, optically controlled oscillator, two-dimensional gas, mixing.

## I. INTRODUCTION

Varactors have extensive applications in communication transceivers and control systems circuitry. They are the main building blocks in Voltage Controlled Oscillators (VCOs). Schottky diode varactors have been vastly investigated for frequency multiplication applications. These devices have symmetric C-V characteristics as well as asymmetric I-V characteristics. This makes them good candidates for generation of odd harmonics with high efficiency [1-2]. Also, due to the lack of charge storage time delays, Schottky diodes have the added advantage of high-speed operation compared to PIN diodes. Their most important property,

however, is that Schottky contacts are routinely deposited as gates of MESFETs, making these devices compatible with unipolar MMIC technology. By comparison PIN and HBT combinations would be the natural choices in bipolar technology. Varactors as variable capacitance devices, they utilize the voltage dependence of semiconductor junction capacitance. Generally, for any semiconductor junction with arbitrary doping profile  $N = B x^m$ , the capacitance equals:

$$C = \frac{\partial Q_c}{\partial V} = \left[ \frac{qB(\epsilon_o\epsilon_r)^{m+1}}{(m+2)(V+V_{bi})} \right]^{1/(m+2)} \quad (1)$$

Eq. (1) shows that the capacitance varies with the reverse terminal applied bias as  $C \propto (V + V_{bi})^{-s}$ , with sensitivity

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$s = (m+2)^{-1}$ . For a uniformly doped abrupt-junction this reduces to the usual inverse square root bias dependence for the capacitance. In Schottky diode varactors the junction capacitance changes as the reverse applied bias voltage depletes the semiconductor channel until it reaches its minimum physical limit. Although some variation due to charge storage can still be observed, further increase on the applied bias typically causes no significant effect.

With the advent of modulation doped devices such as MODFETs, with their improved transconductance, high bandwidth, and high noise margins, development of other devices that take advantage of transport in reduced dimensional regimes becomes important. To that end Schottky diodes in which contact is made to a two dimensional electron gas (2-DEG) have been realized [3-4]. These devices take advantage of the 2-DEG characteristics and produce a lower series resistance while, due to streamlines of the electric field between 2DEG and 3D metal; they achieve wider depletion region and higher breakdown voltage. They have been shown to be efficient frequency triplers in the millimeter and sub-millimeter ranges [5-6]. Up to now we are unaware of any comprehensive theoretical description of the C-V characteristics for such structures. In any case, it has been theoretically expected that the depletion width of the ideal junction between metal to 2DEG is linearly dependent on voltage [7-8] and hence capacitance should show a stronger voltage dependence compared to metal to bulk contact.

In what follows we propose what is, to our knowledge, the first theoretical model of the C-V characteristics of a device in which two back to back Schottky contacts are made to a 2DEG channel formed through modulation doping of a heterostructure. While maintaining desirable properties of the 2-DEG Schottky diode, this heterojunction metal-semiconductor-metal (HMSM) device has the advantage of ease of fabrication, since both contacts are deposited on the same step. The structure is implemented and experimental results are presented. An important distinguishing feature of the novel device proposed here is the addition of a third contact, gate, that allows a second degree of freedom to modulate the capacitance, in particular, and channel characteristics, in general. Since the major potential application of the HMSM device is in optical detection [9], we chose to fabricate the gate for this varactor HMSM by using a thin layer of highly doped  $n^+$  material. This layer is mostly transparent to light hence the device can be optically gated to achieve a third degree of freedom that is very useful for optical mixing applications.

Three-terminal varactors previously investigated have used the gate to source capacitance of the GaAs MESFET [10-12] device using the drain contact as the third terminal. As compared to the device proposed here, the two main advantages are transport in reduced dimensional regime and the light transparency of the gate.

## II. DEVICE DESCRIPTION AND EXPERIMENTAL RESULTS

The structure of the HMSM-varactor is shown in Fig. 1. On top of a buffer layer grown on semi-insulating GaAs substrate, 5000 Å of undoped GaAs was deposited, followed by 100 Å of undoped Al<sub>0.24</sub>Ga<sub>0.76</sub>As and 500 Å of  $3 \times 10^{17} \text{ cm}^{-3}$  n-type Al<sub>0.24</sub>Ga<sub>0.76</sub>As. The topmost layer is 200 Å of  $3 \times 10^{18} \text{ cm}^{-3}$  n-type GaAs layer. All growth was done by molecular beam epitaxy (MBE) and the structure was chosen to be compatible with enhancement type MODFETs where the n<sup>+</sup> cap layer is usually used for ohmic contact formation. A trench was formed by wet chemicals etching through the Al<sub>0.24</sub>Ga<sub>0.76</sub>As layers and 500 Å of Schottky Ti/Au contact metal was deposited on the GaAs side to form Schottky junctions with the 2DEG. The contacts have the usual interdigital structure. Since the cathode and anode terminals are recessed, the top n<sup>+</sup> layer readily becomes available for probing and voltage application. For better electrical access, however, a third metal contact may be deposited on the n<sup>+</sup> layer, away from the interdigital surface. The use of the n<sup>+</sup> layer as transparent electrode has previously been demonstrated in photodetectors, where large increase in responsivity due to better optical coupling was reported [13].

The capacitance-voltage characteristics of the device were measured by directly probing the three terminals and recording the results by a HP LCR meter. Fig. 2 shows the measured capacitance as a function of terminal voltage for two voltages applied to the gate. It is seen that a large variation (about 24%) of capacitance can be obtained when a

signal of -15 volts is applied to the gate terminal. Defining sensitivity of a varactor as the difference between capacitance at zero bias and its minimum physical limit, it is seen that the gate signal substantially extends the sensitivity.

Independently of the physical mechanism responsible for charge modulation by the applied bias, if the voltage is high enough to fully deplete the semiconductor the capacitance between the electrodes will reach a strictly geometrical lower value given by [14]:

$$C_{\text{free}} = L(N-1)\epsilon_0(\epsilon_r + 1) \frac{K(k)}{K(k')} \quad (2)$$

where  $\epsilon_r$  is the relative dielectric constant of the semiconductor,  $\epsilon_0$  is the dielectric permittivity in vacuum, N is the number of electrodes, L is the electrode length and  $k = \cos\left(\frac{\pi}{2}\left(1 - \frac{W}{W+G}\right)\right)$  is a dimensionless quantity, where

W is the electrode width and G is the electrode fingers spacing. This same minimum value was reached when the n<sup>+</sup> and AlGaAs layers were etched. In that case, the zero bias capacitance was slightly higher than the minimum value indicating that most of the bulk material between electrodes was already depleted. In fact, modulation doping reduces this depletion region by virtue of the existence of 2DEG carriers; the gate simply modulates the sheet carrier density and hence changes the capacitance. It should be mentioned that an important attribute of this device is that the terminal current is very low and was always maintained under 10 nA for a 200x200  $\mu\text{m}^2$  device. Previous three terminal varactors

that used MESFET devices need currents in mA range for their operation [10-12]

In Fig. 3 capacitance is plotted as a function of gate voltage for zero terminal bias voltage. It is seen that capacitance changes from 311fF to 417 fF, a change of about 35% for a gate voltage variation of 15 volts. It is observed that a large gate voltage is needed to achieve capacitance modulation. This can be related to the voltage drop along the n<sup>+</sup> layer lines, which, although highly doped, is very thin and has a long length. One way to enhance the device sensitivity to gate voltage is to sacrifice its fabrication simplicity by aligning and depositing gate metal. This solution, however, in addition to requiring more processing effort, would suppress the optical coupling capability.

### III. THEORETICAL MODELING

The model presented in this section is a quasi two-dimensional extension of a work previously published by the authors [15]. Here, we start by self-consistently solving Schrödinger and Poisson equations in the growth direction. The quantum-mechanical formalism is based on the effective mass approximation, where the electron wavefunction is taken as the product of a Bloch function and an envelope function, solution of the time-independent Schrödinger equation:

$$H\phi_i(x) = E_i \phi_i(x) \quad (3)$$

The utilized Hamiltonian takes into account position-dependent effective mass and lattice constant and is given by [15]:

$$H = -\frac{\hbar^2}{2a(x)} \frac{d}{dx} \frac{[a(x)]^2}{m^*(x)} \frac{d}{dx} \frac{1}{a(x)} + V_{ef}(x) \quad (4)$$

where x is taken as the direction perpendicular to the epitaxial layers. The effective potential V<sub>ef</sub> is given as the sum of four terms:

$$V_{ef}(x) = V_e(x) + C_1(\epsilon_{xx} + \epsilon_{yy} + \epsilon_{zz}) + V_H(x) + V_{xc}(x) \quad (5)$$

where V<sub>e</sub> represents the conduction-band edge potential of the undoped structure, i.e., the band-diagram discontinuities and V<sub>H</sub> is the Hartree term due to the electrostatic potential. For completeness, we have also included an exchange-correlation term; V<sub>xc</sub> while the strain caused by lattice mismatch due, for example, to the insertion of an InGaAs pseudomorphic channel layer in between the AlGaAs/GaAs heterojunction can be account for the second term of the RHS of eq. (5). In this term, C<sub>1</sub> is the conduction band deformation potential and ε<sub>xx</sub>, ε<sub>yy</sub> and ε<sub>zz</sub> are the strain components [15].

The Poisson equation, which yields the above mentioned Hartree term, is given by:

$$\frac{d}{dx} \left( \epsilon_0 \epsilon_r(x) \frac{d}{dx} \right) V_H(x) = -q [N_D^+(x) - N_A^-(x) - n(x)] \quad (6)$$

where q is the electronic charge, ε<sub>r</sub>(x) is the position dependent dielectric constant of the semiconductor, N<sub>D</sub><sup>+</sup> is the ionized donor concentration, N<sub>A</sub><sup>-</sup> is the ionized non-intentional background acceptor concentration and n(x) is the

free-electron concentration in the conduction band (the free hole concentration has been neglected). We write  $n(x)$ , in terms of the electronic eigenfunction  $\phi_i(x)$ , as:

$$n(x) = \frac{m_0^* k T}{\pi \hbar^2} \sum_i \ln \left[ 1 + \exp \left( \frac{E_f - E_i}{k T} \right) \right] |\phi_i(x)|^2 \quad (7)$$

where  $m_0^*$  is the electron effective mass in the 2-DEG channel,  $k$  is the Boltzmann constant,  $T$  is the absolute temperature,  $\hbar$  is the reduced Planck constant,  $E_f$  is the Fermi level energy and  $E_i$  represents the  $i$ -th eigenvalue. Summation is carried out over all  $i$  subbands.

The ionized donor concentration  $N_D^+$  is described by:

$$N_D^+(x) = \frac{N_D(x)}{1 + g_n \exp \left[ (E_f - E_d) / k T \right]} \quad (8)$$

where  $N_D$  is the position dependent donor concentration,  $g_n$  is the donor level spin degeneracy factor, taken as equal to 2, and  $E_d$  is donor ionization energy.

The Fermi-level position  $E_f$  is computed from the usual charge neutrality condition in the bulk material and the above formulation (eqs. 3-8) must be solved self-consistently in real space. In particular, the eigenstates of the Schrödinger equation are numerically calculated by using a split-operator algorithm through a non-uniform finite difference discretization scheme [15], under the boundary conditions that the wavefunction must vanish at the substrate and at the Schottky barrier. The boundary conditions for the Poisson equation are given by the applied gate voltage  $V_g$  at the Schottky barrier (taken as  $x = 0$ ) as well as by the position of the conduction band with respect to the Fermi-level in the

bulk semiconductor, presenting a non-intentional background ionized doping density  $N_A^-$ . The solution yields the charge control relation between the gate voltage  $V_g$  and the sheet electron density  $n_s$  into the channel, i.e.  $n_s = f(V_g)$  [16-17]. Now, this charge control relation is used as an input to develop the first quasi two-dimensional for the capacitance-voltage characteristics of “gated” HMSM devices (see Fig. 1). The  $y$ -component of the potential distribution along the channel,  $V(y)$ , is taken into account by, as usually done [16-17] in the modeling of other 2-DEG based devices, assuming that if  $n_s = f(V_g)$  one can write  $n_s(y) = f(V_g - V(y))$ , preserving the same functional dependence  $f(\cdot)$ .

Accordingly, in our procedure, for a given terminal voltage, the channel is initially divided into several segments of length  $dy$ . Next, the capacitance contribution of each segment is computed by solving the one-dimensional Schrodinger-Poisson problem in the growth direction (eqs. 3-8), but now under an “effective” gate potential  $V_g' = V_g - V(y_i)$ , where  $y_i$  is a coordinate position located in middle of each segment. A quasi-static approach was used, giving the capacitance per unit area as the total charge variation caused by a small voltage change around a given bias point.

Then, this free-carrier capacitance,  $C_{free}$ , is given by the summation of the capacitance contribution for each segment  $dy$ . The overall device capacitance is finally written as:

$$C_T = C_{free} + C_G \quad (9)$$

where  $C_G$  is the geometry-related component, given by eq. 2.

The model is expected to provide reliable results as long as an accurate expression for  $V(y)$  is used (see, for example, reference [8]) and the length of each segment  $dy$  is small enough. Fig. 4 displays the free-carrier capacitance contribution (see eq. 9) as a function of the terminal voltage for a heterodimensional Schottky-ohmic device, without a gate contact. The simulated presents the same layer structure as the fabricated varactors discussed in the previous section and a total area of  $40 \mu\text{m} \times 40 \mu\text{m}$ . Since there is no gate present, in the simulations  $V_g$  was replaced by a surface potential of  $0.75\text{V}$ , due to surface states at the AlGaAs/air interface.

The theoretical results obtained are quite promising. It is clearly seen that our model was able to reproduce, without any fitting parameter, the general features of the varactor C-V characteristics, yielding capacitance values in the measured range. Given the uncertainty on some device parameters (such as the amount of non-intentional doping at the GaAs buffer layer and value of the surface potential at the top of the structure) no attempt will be made in this paper to directly match theory and experiment. However, due to satisfactory results obtained above, we believe that this novel model will be a powerful tool to optimize the device performance, by providing useful design guidelines. Further results will be presented elsewhere.

#### IV.CONCLUSIONS

A novel gate-controlled varactor was realized. The device takes advantage of Schottky contact to a 2DEG, which is produced by modulation doping of an AlGaAs/GaAs heterojunction. The gate is formed from an n+ cap layer that is normally used for ohmic contact deposition. Therefore, device growth architecture is the same as the used in MODFETs.

The gated device extends the sensitivity of a comparable device fabricated without the gate by about 24% while the zero bias capacitance can be changed by 35% for a gate voltage variation of 15 volts. This adds a degree of controllability to reach the DC free running oscillator frequency design goal, especially useful in a low yield MMIC process. Another application of this device is operation as a mixer because the capacitance and thus the oscillating frequency are both a function of the terminal and the gate voltages  $V_t$  and  $V_g$ , respectively, i.e.,  $C = f(V_t, V_g)$ . This means that frequency can be modulated by a mixed signal from gate and junction terminals. A further application of the device is the one where the varactor is in parallel with an active device and the variation of the terminal voltage affects the operating point of the active network. The varactor gate can be utilized to modulate the junction capacitance without introducing added bulky isolation circuits. Also, another important feature of the varactor is the optical transparency of the gate. This allows for optical gating of the varactor and makes it a good candidate as an optically controlled oscillator (OCO). Finally, since carrier

transport along the two terminals is determined by Schottky-2DEG contact, current conduction remains under 10 nA for a relatively large size device. Hence, power consumption remains minimal and the device behaves quite favorably compared to MODFET based OCO's [5]. It is believed that the use of the quasi two-dimensional C-V model presented in this paper will allow a further enhancement of the varactor performance.

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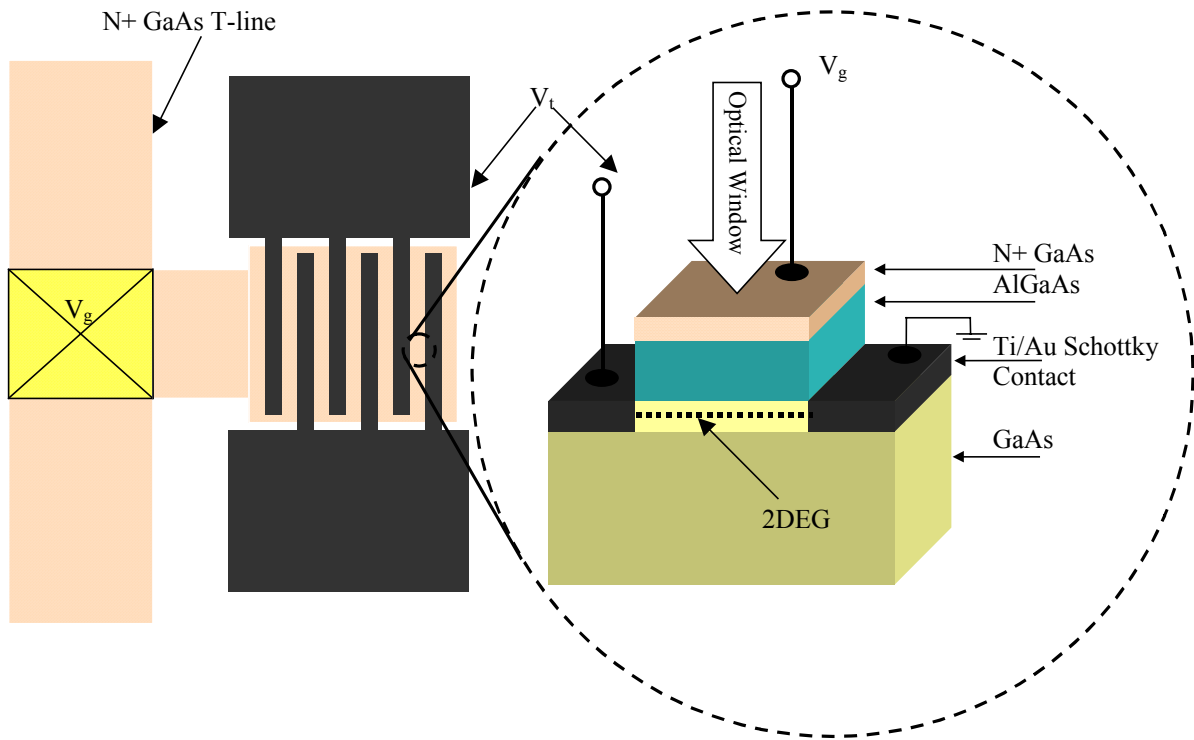
#### FIGURE CAPTIONS

Fig. 1. Structure of the 2DEG varactor showing terminal contacts and the  $n^+$  transparent gate.

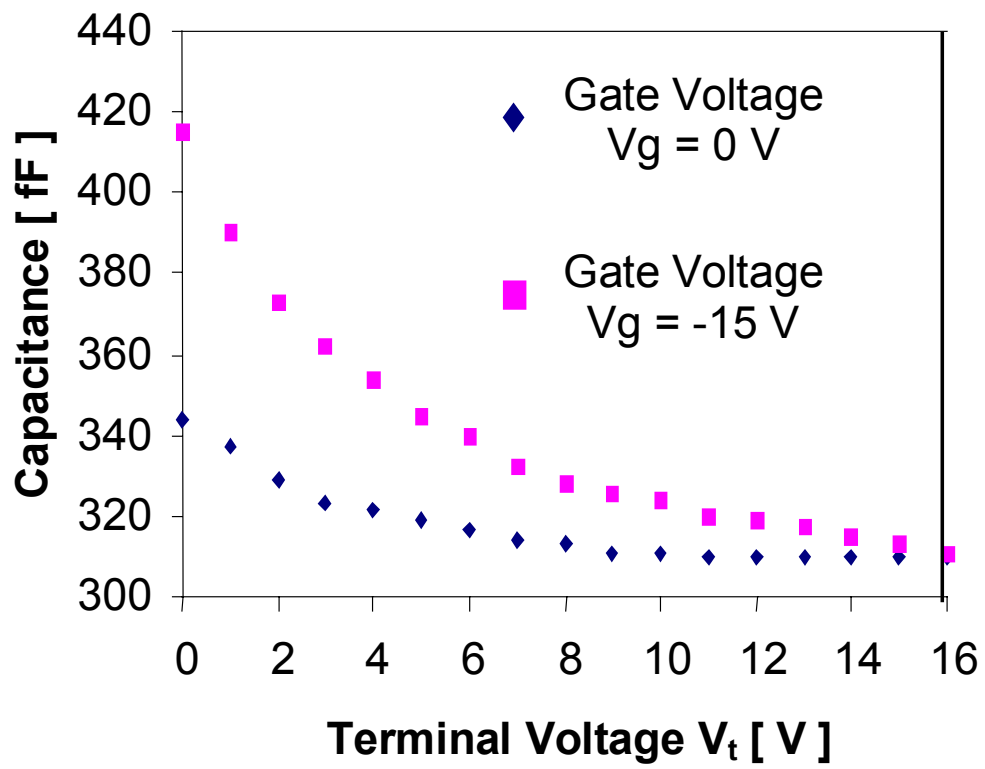
Fig. 2. Variation of terminal capacitance with terminal voltage for two gate voltages.

Fig. 3. Modulation of terminal capacitance with gate voltage at zero terminal voltage.

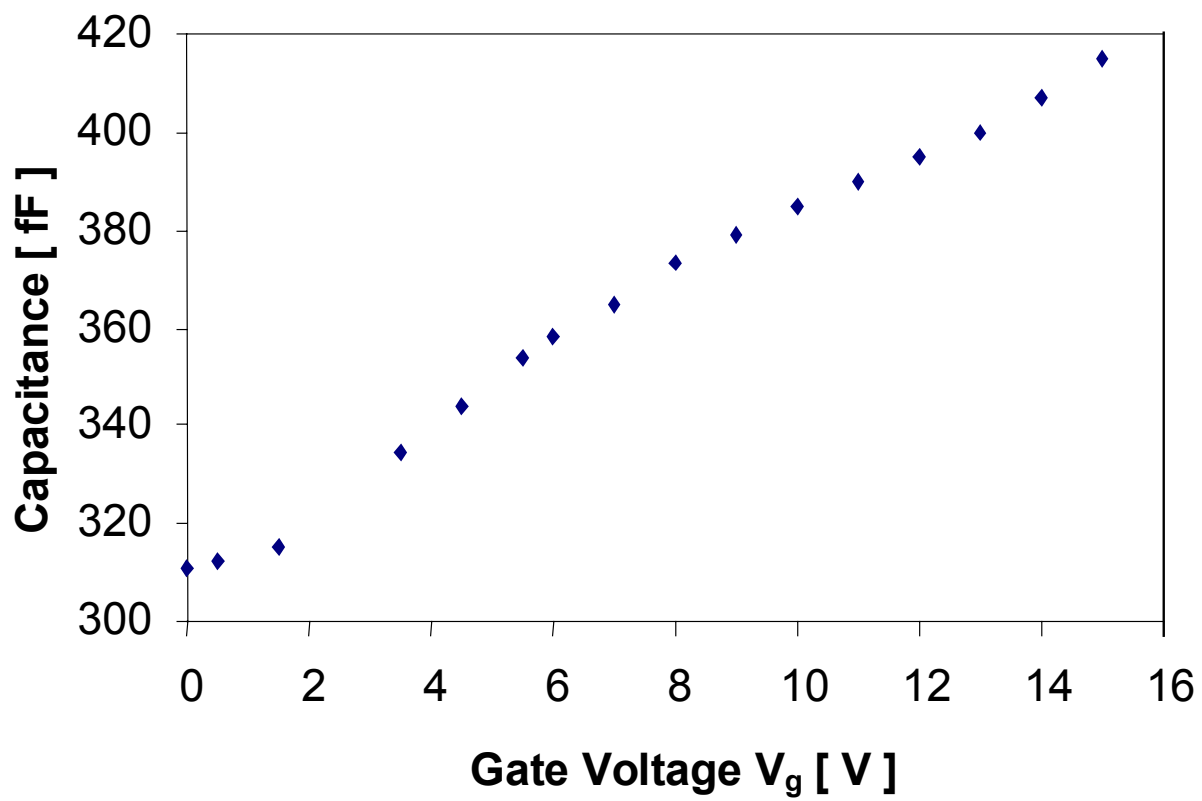
Fig. 4. Free-carrier contribution for the capacitance for a Schottky-Ohmic heterodimensional device. The figure does not include the capacitance component described by eq. (2). For the geometric contribution reference [14] yields 23.6 fF although a value of 29 fF was measured.



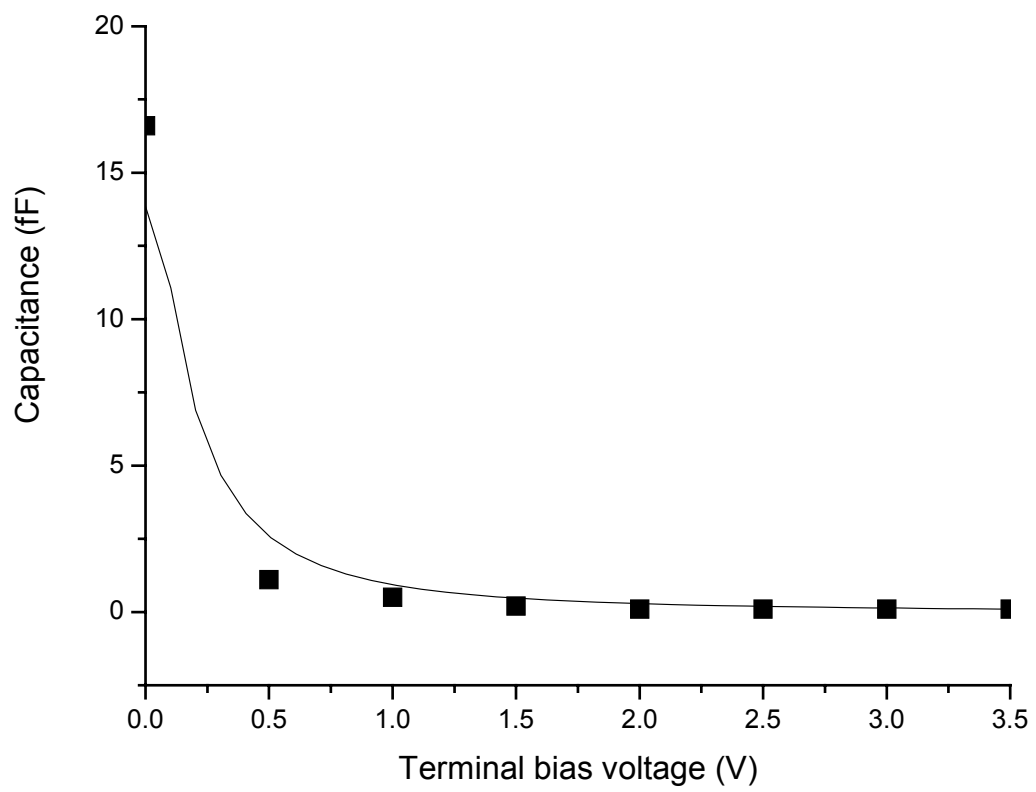
**Fig. 1**



**Fig.2**



**Fig. 3**



**Fig. 4**